

### Surface Mount Schottky Barrier Rectifier

**Reverse Voltage - 20 to 200 V**

**Forward Current - 1.0 A**

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View

Simplified outline SMAF and symbol

### FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

### MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg/0.00095oz

### Absolute Maximum Ratings and Electrical characteristics

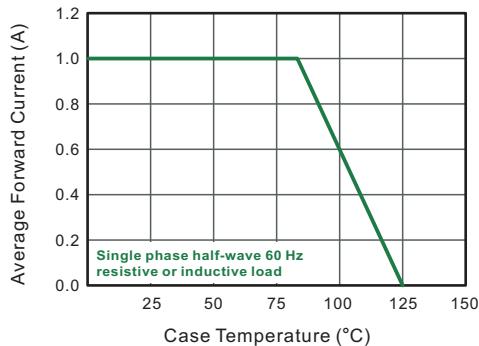
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS12F	SS14F	SS16F	SS18F	SS110F	SS112F	SS115F	SS120F	Units								
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	20	40	60	80	100	120	150	200	V								
Maximum RMS voltage	$V_{RMS}$	14	28	42	56	70	84	105	140	V								
Maximum DC Blocking Voltage	$V_{DC}$	20	40	60	80	100	120	150	200	V								
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1.0								A								
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	$I_{FSM}$	25								A								
Max Instantaneous Forward Voltage at 1 A	$V_F$	0.55		0.70		0.85		0.90		V								
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 100^\circ\text{C}$	$I_R$	0.3 10			0.2 5			0.1 2		mA								
Typical Junction Capacitance <sup>(1)</sup>	$C_j$	110		80						pF								
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	95								°C/W								
Operating Junction Temperature Range	$T_j$	-55 ~ +125								°C								
Storage Temperature Range	$T_{stg}$	-55 ~ +150								°C								

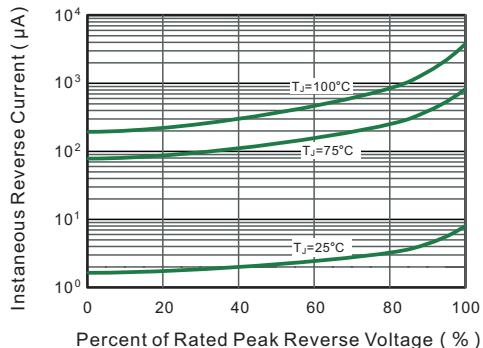
( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

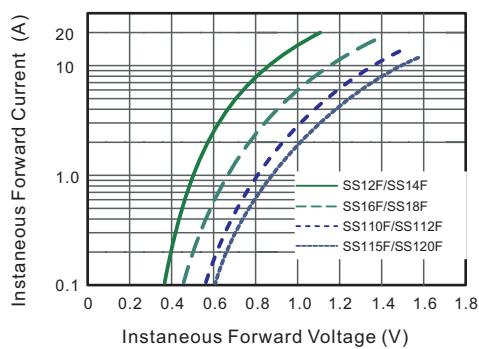
**Fig.1 Forward Current Derating Curve**



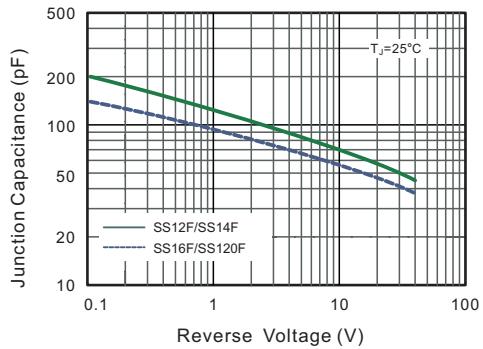
**Fig.2 Typical Reverse Characteristics**



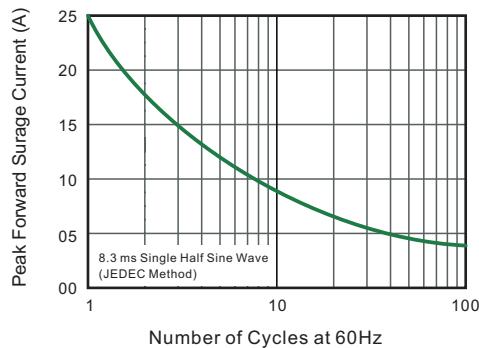
**Fig.3 Typical Forward Characteristic**



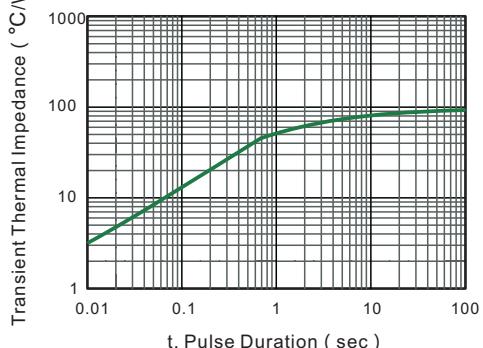
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**

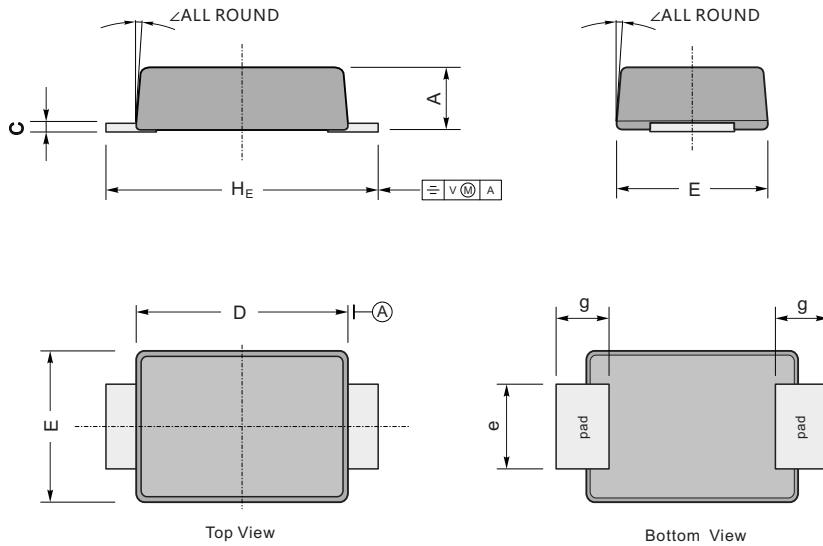


**Fig.6- Typical Transient Thermal Impedance**



### PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



UNIT		A	C	D	E	e	g	H <sub>E</sub>	∠
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	47	7.9	146	106	63	47	193	7°
	min	35	4.7	130	94	51	31	173	

### The recommended mounting pad size

